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Enclosed for recording is Assignment documentation for the following patent application:

Attorney Docket No.: DP-314056

(1) Assignor/Inventors: Darrel E. Peugh; Bruce A. Myers; and Gary E. Oberlin

(2) Assignee: DELPHI TECHNOLOGIES, INC.
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(3) Assignment of patent application

(4) Application number:
If blank, this documentation is filed together with the patent application.

(5) Address correspondence to: Stefan V. Chmielewski
DELPHI TECHNOLOGIES, INC.
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(6) Number of applications: 1
Total Fee: 40.00

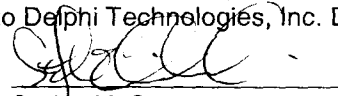
Date documentation executed: 3-15-06; 3-15-06; and 3-15-06.

(8) Not applicable

(9) To the best of my knowledge and belief, the information contained on this cover sheet is true and correct and any copy submitted is a true copy of the original document.

Title: FLUID COOLED ELECTRONIC ASSEMBLY

Please charge the \$ 40.00 assignment recordal fee to Delphi Technologies, Inc. Deposit Account No. 50-0831.


Stefan V. Chmielewski

Total number of pages including cover sheet, attachments and document: 2

Enclosures

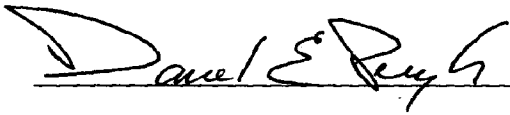
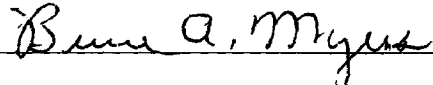
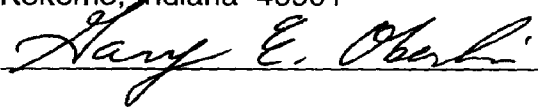
PATENT
REEL: 017757 FRAME: 0102

ASSIGNMENT

Pursuant to an agreement with my employer, I formally assign to DELPHI TECHNOLOGIES INC., the entire right, title and interest, in all countries, in the improvements set forth in the United States patent application DP-314056 entitled

FLUID COOLED ELECTRONIC ASSEMBLY

for which I executed a declaration dated as indicated below. If the patent application has been filed, I authorize the Vice President of Delphi Technologies, Inc., or his designate, to insert the application number and filing date of said application here in parentheses (_____ filed _____) when known.

Inventor's signature	<u></u>	Date	<u>3-15-06</u>
Full name:	Darrel E. Peugh	Declaration dated:	
Residence:	Kokomo, Indiana 46901		<u>3-15-06</u>
Inventor's signature	<u></u>	Date	<u>3/15/06</u>
Full name:	Bruce A. Myers	Declaration dated:	
Residence:	Kokomo, Indiana 46901		<u>3/15/06</u>
Inventor's signature	<u></u>	Date	<u>3/15/06</u>
Full name:	Gary E. Oberlin	Declaration dated:	
Residence:	Windfall, Indiana 46076		<u>3/15/06</u>

PATENT**RECORDED: 04/03/2006****REEL: 017757 FRAME: 0103**